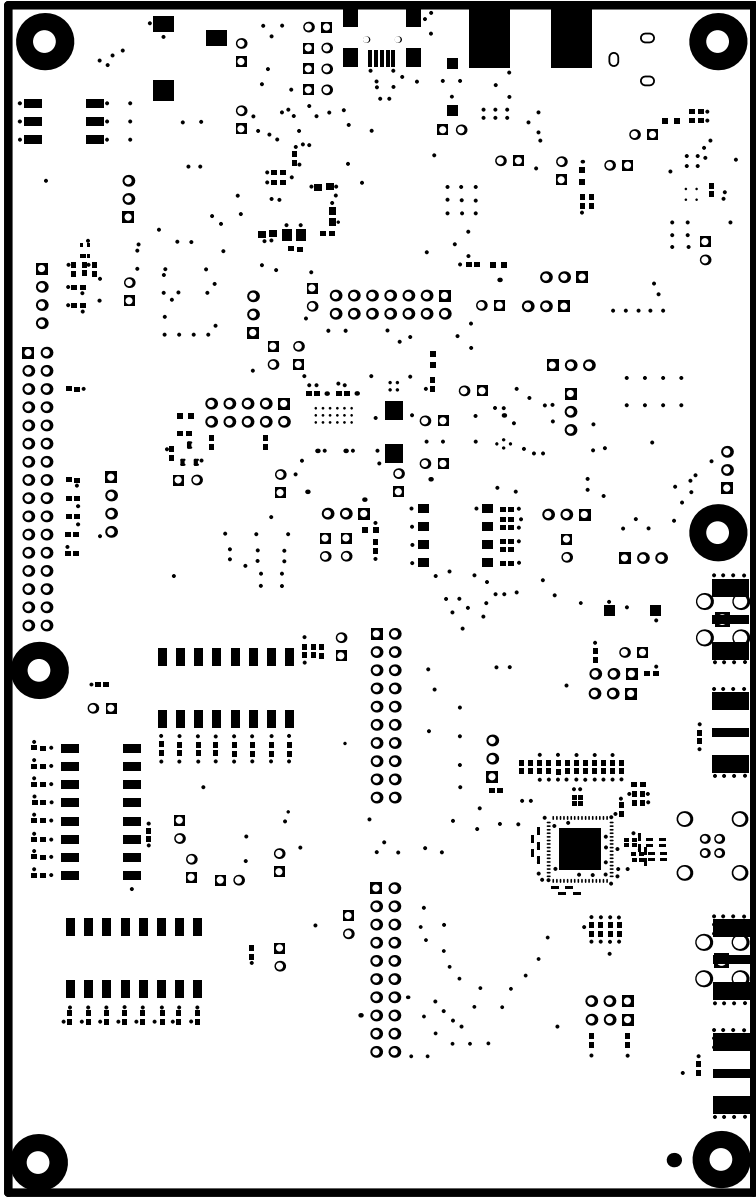
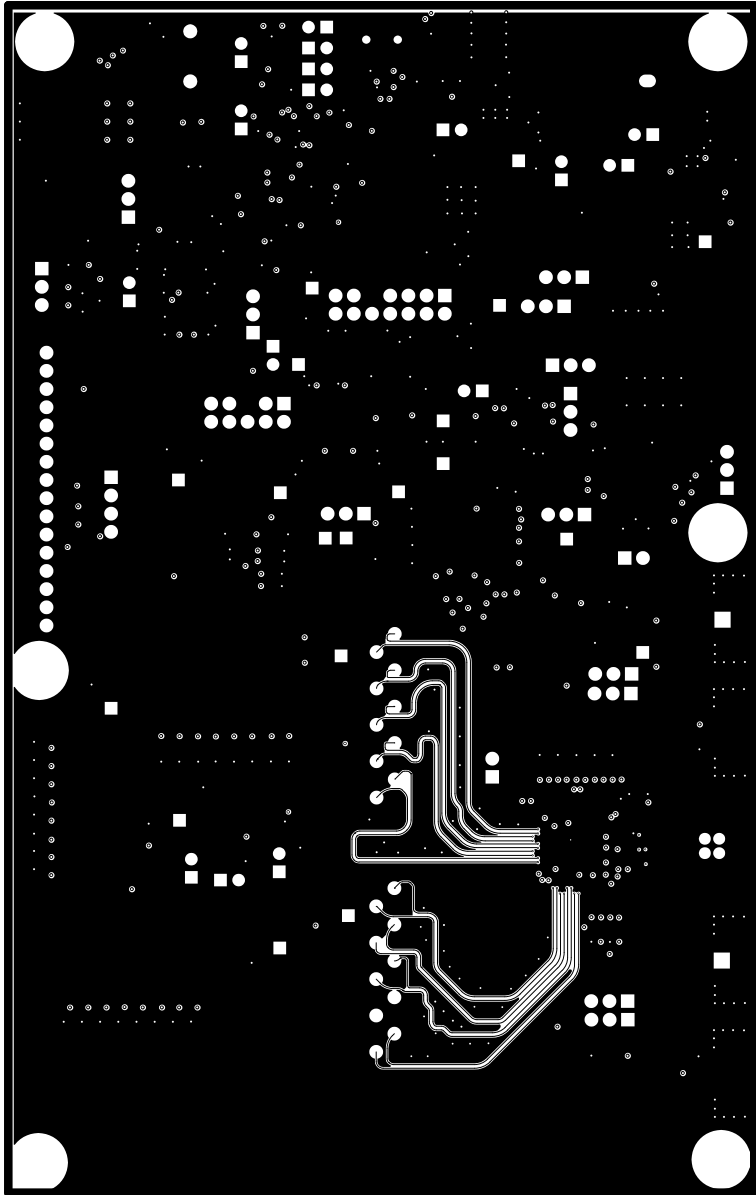


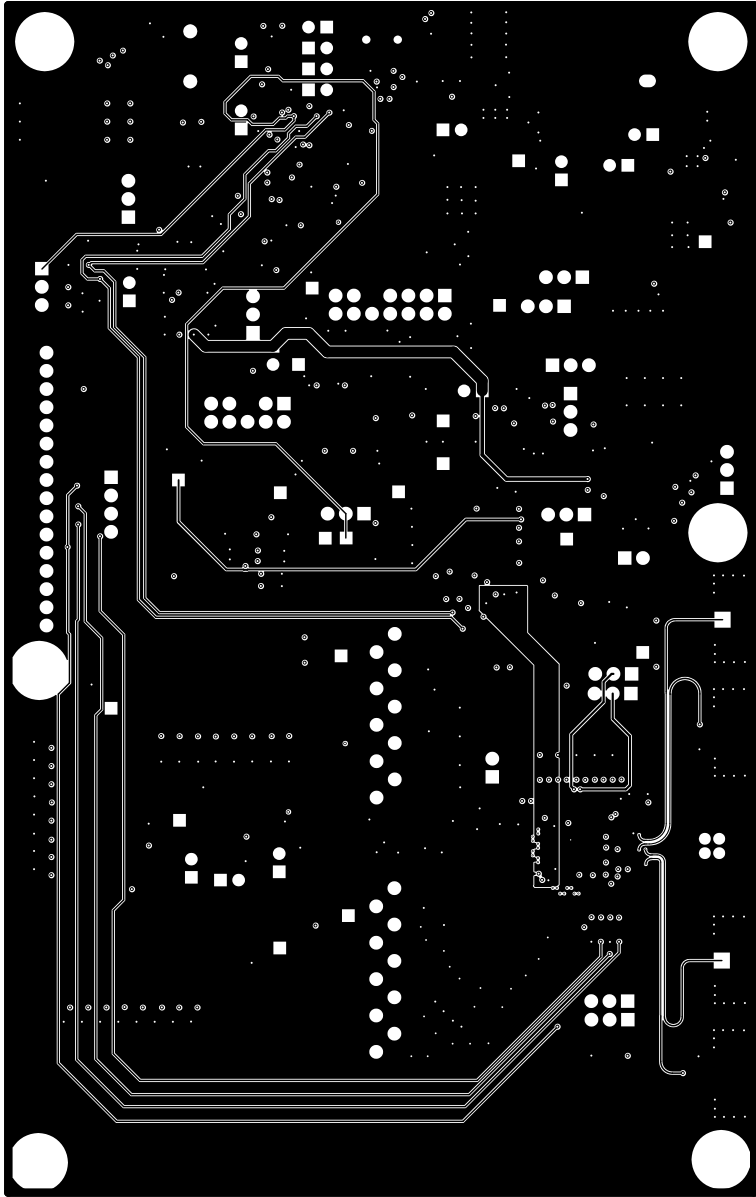
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = Top Overlay			
GENERATED : 9/23/2015 8:08:28 AM		TEXAS INSTRUMENTS	



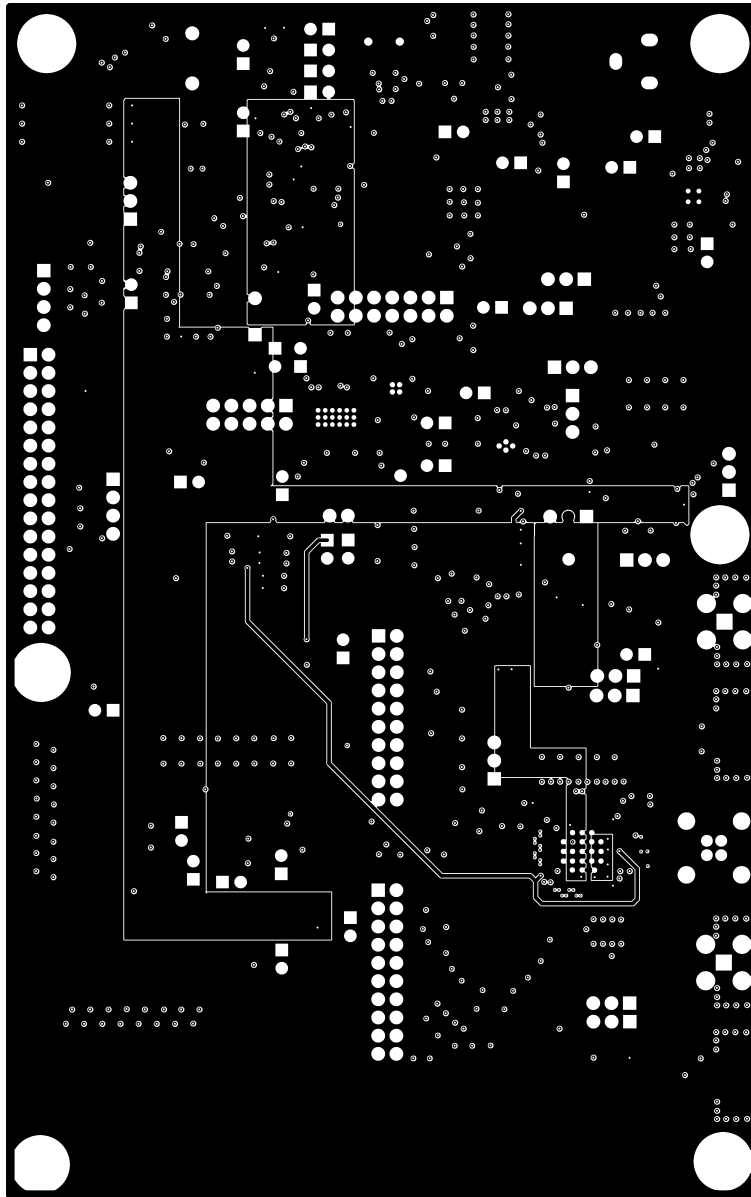
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = <u>SopD512812</u> (PRIMARY SIDE)			
GENERATED : 9/23/2015 8:08:32 AM		TEXAS INSTRUMENTS	



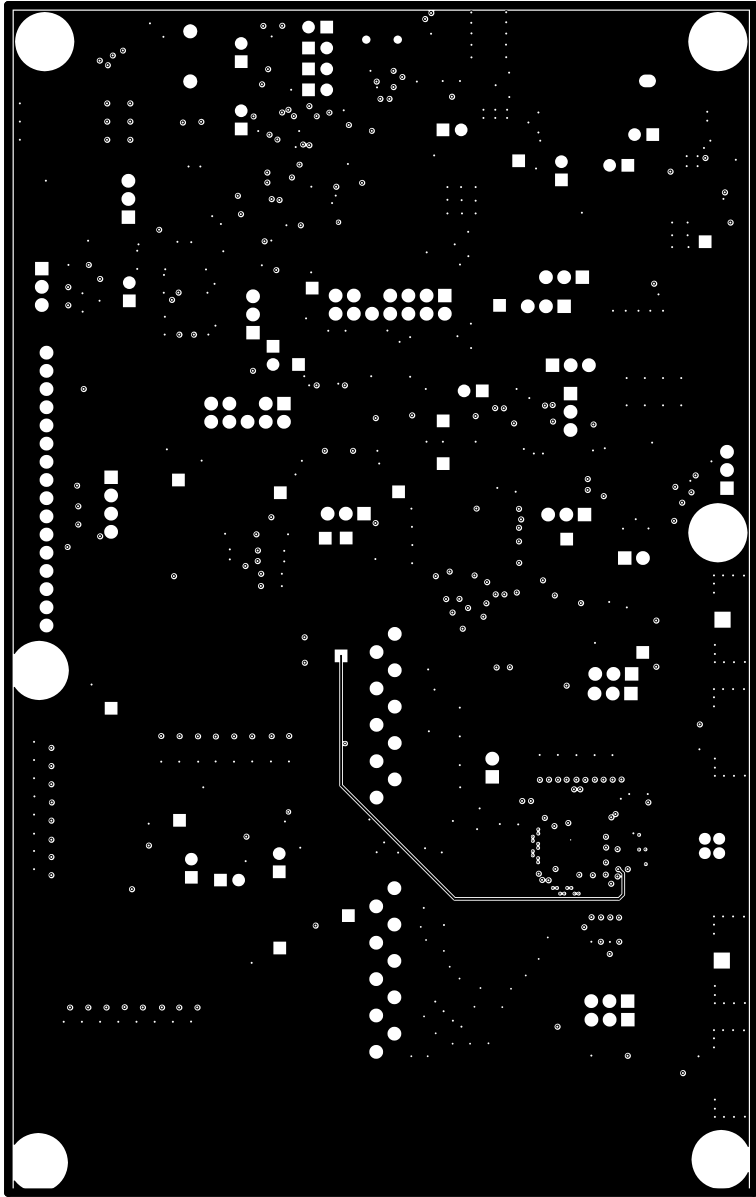
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = <u>D09YBND#1</u> (GROUND PLANE)			
GENERATED : 9/23/2015 8:08:42 AM		TEXAS INSTRUMENTS	



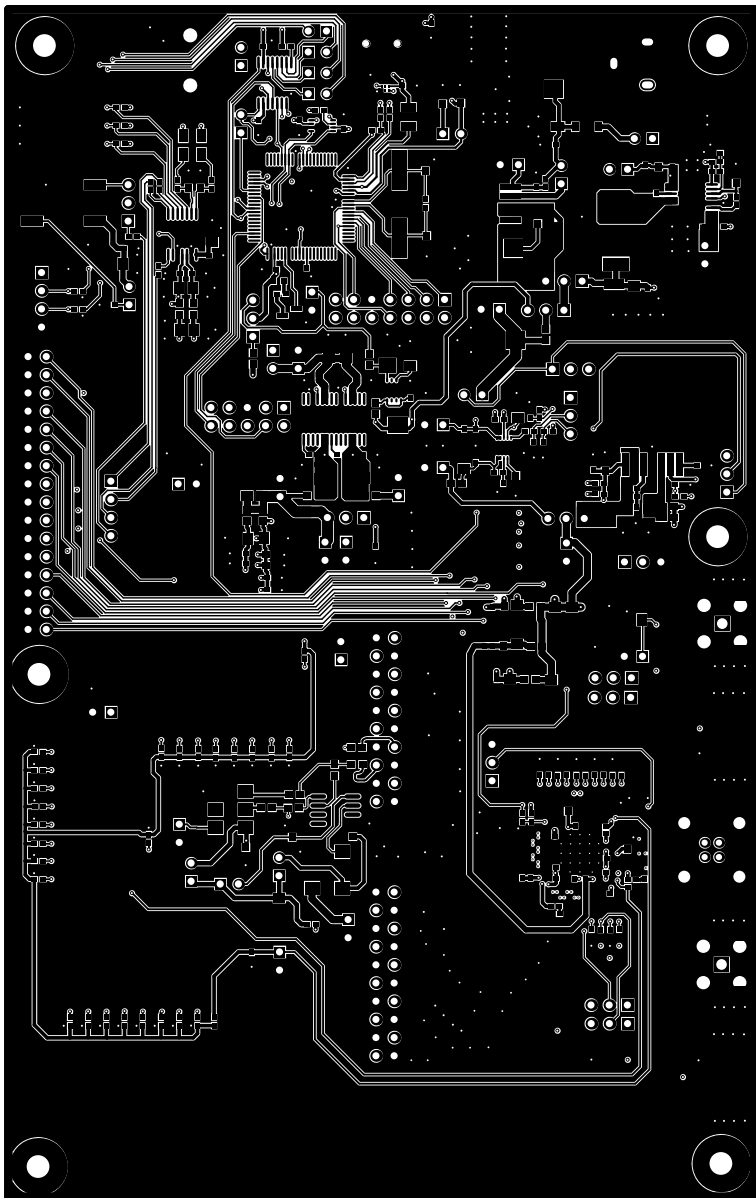
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = <u>D8Y50G81</u> (POWER PLANE)			
GENERATED	: 9/23/2015	8:08:49 AM	TEXAS INSTRUMENTS



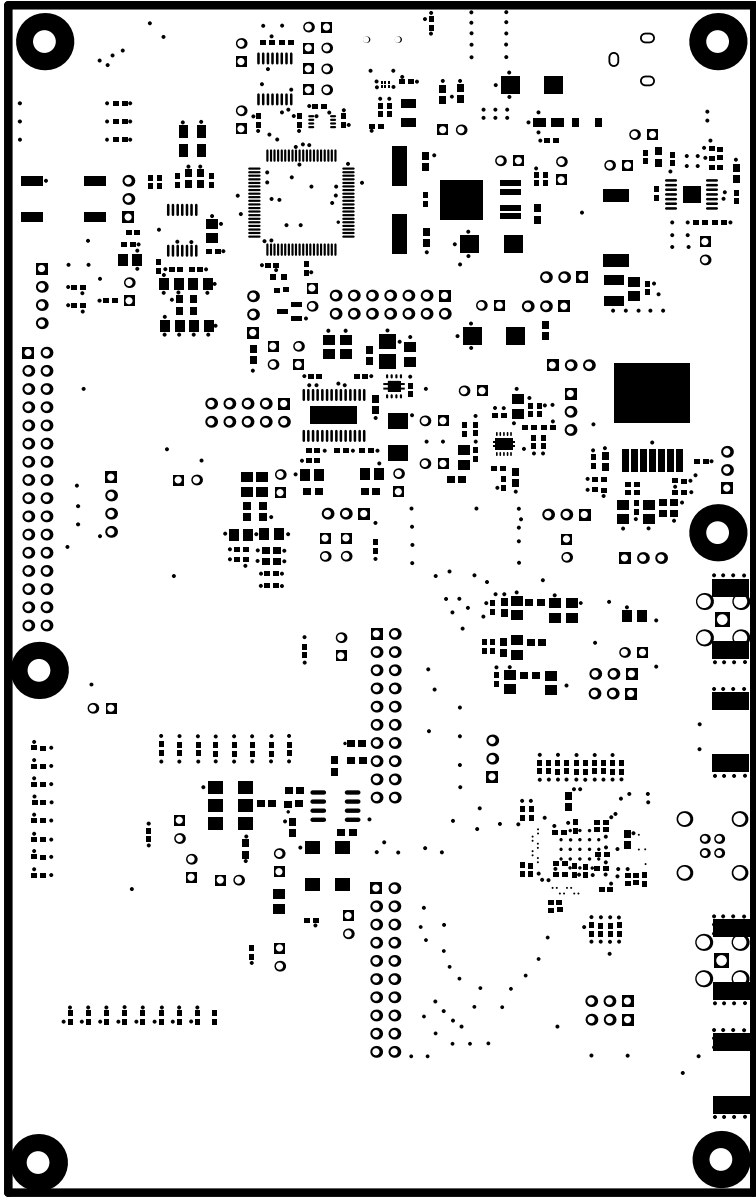
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = 04_PWR#1			
	GENERATED : 9/23/2015 8:08:57 AM	TEXAS INSTRUMENTS	



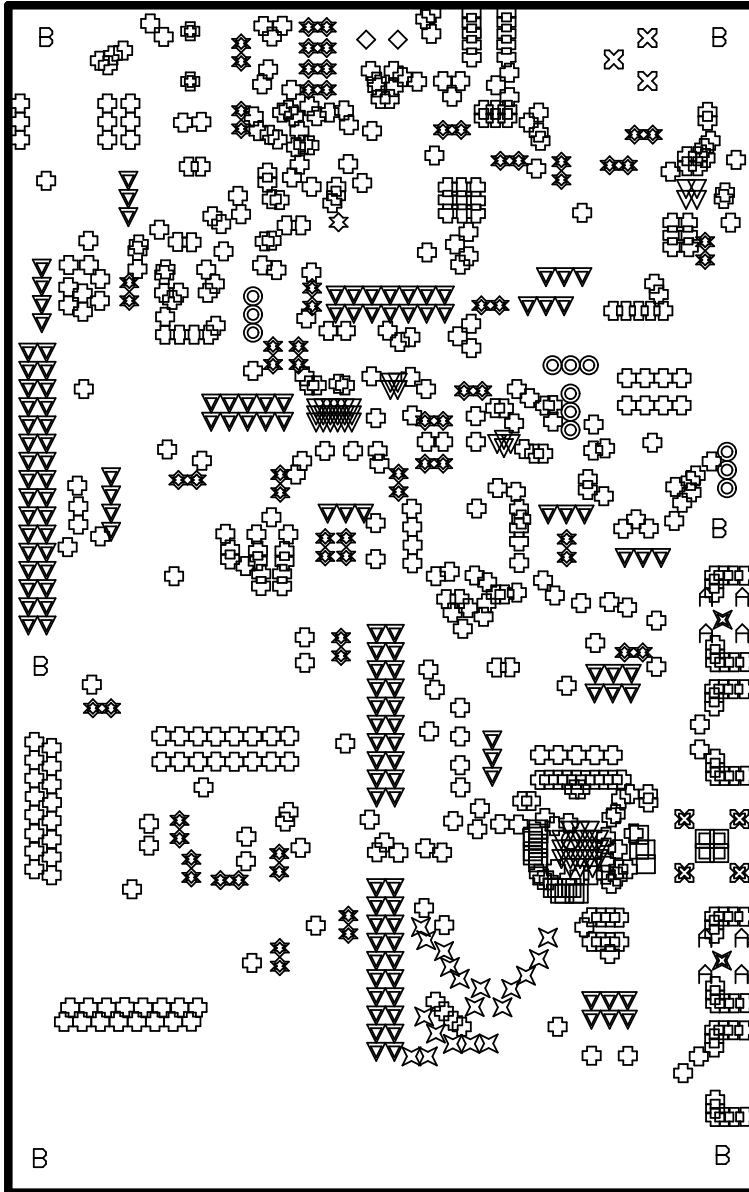
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = 05_GND#2			
	GENERATED : 9/23/2015 8:09:05 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = <u>Boyer_0m4L</u> (SECONDARY SIDE)			
GENERATED : 9/23/2015 8:09:16 AM		TEXAS INSTRUMENTS	

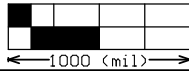
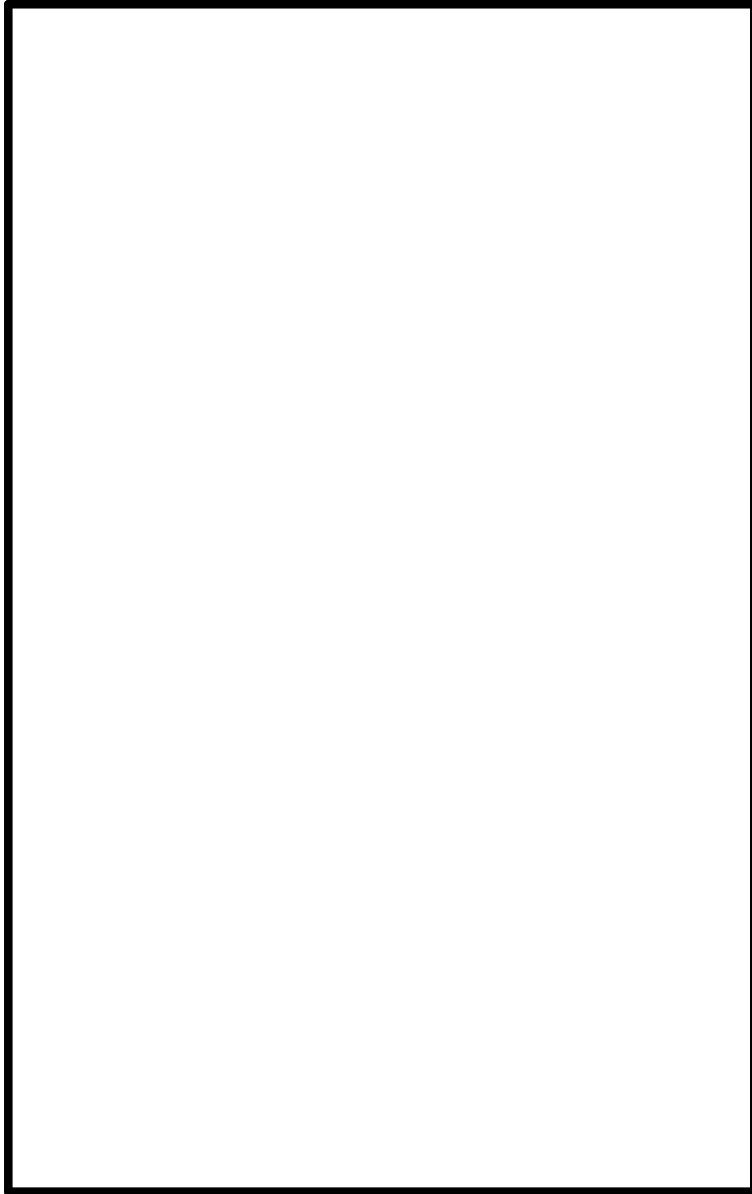


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = <u>SOLDER MASK (SECONDARY SIDE)</u>			
GENERATED : 9/23/2015 8:09:25 AM		TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
◇	2	0.900mm (35.43mil)	NPTH	Round
⊕	2	1.700mm (66.93mil)	NPTH	Round
□	22	0.152mm (6.00mil)	PTH	Round
○	1	0.200mm (7.87mil)	PTH	Round
▽	50	0.200mm (7.87mil)	PTH	Round
☆	1	0.254mm (10.00mil)	PTH	Round
⊗	19	0.279mm (11.00mil)	PTH	Round
⊕	503	0.305mm (12.00mil)	PTH	Round
⊞	4	0.900mm (35.43mil)	PTH	Round
⊙	12	1.000mm (39.37mil)	PTH	Round
▽	137	1.016mm (40.00mil)	PTH	Round
☆	70	1.020mm (40.16mil)	PTH	Round
⊗	2	1.500mm (59.06mil)	PTH	Round
⊞	4	1.700mm (66.93mil)	PTH	Round
⊞	8	1.900mm (74.80mil)	PTH	Round
B	6	3.200mm (125.98mil)	PTH	Round
⊗	3	1.000mm (39.37mil)	PTH	Slot
	846 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = Drill Drawing			
GENERATED : 9/23/2015 8:09:44 AM		TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	REV: A	SUN REV: Not In VersionControl
PLOT NAME = Board Dimensions			
GENERATED : 9/23/2015 8:09:55 AM		TEXAS INSTRUMENTS	

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